П

Prior Foreign Application(s)

- Case No. 10322/26

Priority Claimed

DECLARATION FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

and was amended on _____ (if applicable).

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled Microparticles, the specification of which:

is attached hereto.

was filed on August 15, 2001 as Application Serial No. 09/931,640.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the patentability as defined in Title 37. Code of Federal Regulations, § 1.56(a).

I hereby claim foreign priority benefits under 35 U.S.C. § 119(a)-(d) or § 365(b) of any foreign application(s) for patent or inventor's certificate or § 365(a) of any PCT International application which designated at least one country other than the United States, listed helow and have also identified below, by checking the box, any foreign application for patent or inventor's certificate, or PCT International application having a filing date before that of the application on which priority is claimed:

(Number)	(Country)	(Day/Month/Ye	ar Filed)	Yes	No
I hereby claim the benefit	under 35 U.S.C. § 119(e) of any United States provision	nal application(s) listed below:		
60/225.525		August 15, 2000			
(Application Ser	ial No.)	(Filing Date)			
60/225,62	0	August 15, 2000			
(Application Ser	ial No.)	(Filing Date)			
application designating the is not disclosed in the pr U.S.C. § 112, I acknowled	ne United States, listed be for United States or PCT adge the duty to disclose	20 of any United States application and, insofar as the subject of International application in the einformation which is material of the prior application and the state of the subject of t	t matter of each of the claims o e manner provided by the first Il to patentability as defined in	f this app paragraph 37 CFI	plication ph of 35 R § 1.56
(Application Seri	al No.)	(Filing Date)	(Status-patented, pendi	ng, aban	doned)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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